

BTS Mates:

BSS

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SPECIFICATIONS

Insulator Material: Liquid Crystal Polymer Terminal Material: Phosphor Bronze
Contact Material: Phosphor Bronze **Plating:** Au or Sn over 50 μ" (1.27 μm) Ni **Current Rating:** 1.8 A per pin (2 pins powered) **Operating Temp Range:** -55 °C to +125 °C

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max Board Stacking:

For applications requiring more than two connectors per board or 100 positions or higher, contact ipg@samtec.com

ALSO AVAILABLE MOQ Required

30 μ" (0.76 μm) Gold Other platings Other positions

MATED HEIGHT

LEAD STYLE MATED HEIGHT*

(5.00 mm) .197"

*Processing conditions will affect mated height.



Some lengths, styles and options are non-standard, non-returnable.



-025, -050, -075, -100

PLATING OPTION

Gold Flash

= 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

on contact, Matte Tin on tail

= (7.00 mm).275" DIA Polyimide Film Pick & Place Pad

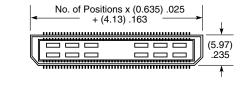
= Tape & Reel (–100 positions max.)

OTHER

OPTION

-K

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks) (–100 positions max.)









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OPTION









-025, -050, -075, -100

Gold Flash on contact, Matte Tin on tail

-L = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

-TR

= Tape & Reel (–100 positions maximum)

-FR = Full Reel Tape & Reel (must order maximum quantity per reel; contact Samtec for quantity breaks) (-100 positions maximum)

